

2MBI200UB-120

e-Front runners

IGBT Module U-Series

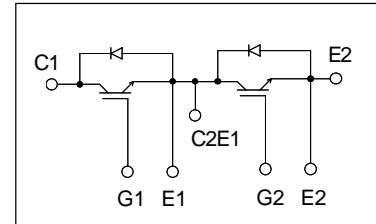
1200V / 200A 2 in one-package

■ Features

- High speed switching
- Voltage drive
- Low inductance module structure
- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines

■ Applications

■ Equivalent Circuit Schematic



■ Maximum ratings and characteristics

● Absolute maximum ratings (at $T_c=25^\circ\text{C}$ unless otherwise specified)

| Item | Symbol | Conditions | | Rating | Unit |
|---|--------------|--------------------|------------------------|-------------|------------------|
| Collector-Emitter voltage | V_{CES} | | | 1200 | V |
| Gate-Emitter voltage | V_{GES} | | | ± 20 | V |
| Collector current | I_C | Continuous | $T_c=25^\circ\text{C}$ | 300 | A |
| | | | $T_c=80^\circ\text{C}$ | 200 | |
| | I_{CP} | 1ms | $T_c=25^\circ\text{C}$ | 600 | |
| | | | $T_c=80^\circ\text{C}$ | 400 | |
| | $-I_C$ | | | 200 | |
| | $-I_C$ pulse | | | 400 | |
| Collector Power Dissipation | P_C | 1 device | | 1040 | W |
| Junction temperature | T_J | | | +150 | $^\circ\text{C}$ |
| Storage temperature | T_{STG} | | | -40 to +125 | |
| Isolation voltage between terminal and copper base *1 | V_{ISO} | AC:1min. | | 2500 | VAC |
| Screw Torque | Mounting *2 | | | 3.5 | N·m |
| | Terminals *2 | | | 3.5 | |

*1 : All terminals should be connected together when isolation test will be done.

*2 : Recommendable value : Mounting 2.5 to 3.5 N·m(M5)

● Electrical characteristics (at $T_j=25^\circ\text{C}$ unless otherwise specified)

| Item | Symbols | Conditions | Characteristics | | | Unit |
|--------------------------------------|------------------------------------|---|-------------------------|------|------|------------------|
| | | | Min. | Typ. | Max. | |
| Zero gate voltage collector current | I_{CES} | $V_{GE}=0\text{V}, V_{CE}=1200\text{V}$ | — | — | 2.0 | mA |
| Gate-Emitter leakage current | I_{GES} | $V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}$ | — | — | 400 | nA |
| Gate-Emitter threshold voltage | $V_{GE(\text{th})}$ | $V_{CE}=20\text{V}, I_C=200\text{mA}$ | 4.5 | 6.5 | 8.5 | V |
| Collector-Emitter saturation voltage | $V_{CE(\text{sat})}$ (terminal) | $V_{GE}=15\text{V}, I_C=200\text{A}$ | $T_j=25^\circ\text{C}$ | — | 1.95 | 2.30 |
| | | | $T_j=125^\circ\text{C}$ | — | 2.20 | — |
| | $V_{CE(\text{sat})}$ (chip) | $T_j=25^\circ\text{C}$ | — | 1.75 | 2.10 | |
| | | $T_j=125^\circ\text{C}$ | — | 2.00 | — | |
| Input capacitance | C_{IES} | $V_{CE}=10\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$ | — | 22 | — | nF |
| Turn-on time | t_{on} | $V_{CC}=600\text{V}$ $I_C=200\text{A}$ $V_{GE}=\pm 15\text{V}$ $R_G=3\Omega$ | — | 0.36 | 1.20 | μs |
| | t_r | | — | 0.21 | 0.60 | |
| | $t_{ri(i)}$ | | — | 0.03 | — | |
| | t_{off} | | — | 0.37 | 1.00 | |
| Turn-off time | t_f | | — | 0.07 | 0.30 | |
| | V_F (terminal) | $V_{GE}=0\text{V}$ $I_F=200\text{A}$ | $T_j=25^\circ\text{C}$ | — | 1.80 | 2.10 |
| | | | $T_j=125^\circ\text{C}$ | — | 1.90 | — |
| | | | $T_j=25^\circ\text{C}$ | — | 1.60 | 1.90 |
| | V_F (chip) | | $T_j=125^\circ\text{C}$ | — | 1.70 | — |
| Reverse recovery time | t_{rr} | $I_F=200\text{A}$ | — | — | 0.35 | μs |
| Lead resistance, terminal-chip*3 | R_{lead} | | — | 0.97 | — | $\text{m}\Omega$ |

*3: Biggest internal terminal resistance among arm.

● Thermal resistance characteristics

| Items | Symbols | Conditions | Characteristics | | | Unit |
|----------------------------|-----------------|-----------------------|-----------------|-------|------|---------------------------|
| | | | Min. | Typ. | Max. | |
| Thermal resistance | $R_{th(j-c)}$ | IGBT | — | — | 0.12 | $^\circ\text{C}/\text{W}$ |
| | $R_{th(j-c)}$ | FWD | — | — | 0.20 | $^\circ\text{C}/\text{W}$ |
| Contact Thermal resistance | $R_{th(c-f)}^*$ | With thermal compound | | 0.025 | — | $^\circ\text{C}/\text{W}$ |

*4 : This is the value which is defined mounting on the additional cooling fin with thermal compound.